

Docket No.: M4065.0248-C
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Allen McTeer

Application No.: Not yet assigned

Confirmation No.:

Filed: September 8, 2003

Art Unit: 2813

For: A MULTI-LAYERED COPPER BOND
PAD FOR AN INTEGRATED CIRCUIT

Examiner: T. Nguyen

INFORMATION DISCLOSURE STATEMENT (IDS)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 CFR 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO/SB/08. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement accompanies the new patent application submitted herewith.

Those patent(s) or publication(s) which are marked with an asterisk (*) next to the Cite No. in the attached form PTO/SB/08 (facsimile) are not supplied because they were previously cited by or submitted to the Office in a prior application numbers 10/079,858, filed February 22, 2002, 10/378,934, filed March 5, 2003, and 09/532,087, filed April 16, 2002, and relied upon in this application for an earlier filing date under 35 U.S.C. 120.

In accordance with 37 CFR 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 CFR 1.56(a) exists. In accordance with 37 CFR 1.97(h), the filing of this Information Disclosure statement shall not be construed to be an admission that any patent, publication or other information referred to therein is "prior art" for this invention unless specifically designated as such.

It is submitted that the Information Disclosure Statement is in compliance with 37 CFR 1.98 and the Examiner is respectfully requested to consider the listed references.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 04-1073, under Order No. M4065.0248/P248-A. A duplicate copy of this paper is enclosed.

Dated: September 8, 2003

Respectfully submitted,

By 

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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known	
				Application Number	Not Yet Assigned
				Filing Date	Herewith
				First Named Inventor	Allen McTeer
				Art Unit	2813
				Examiner Name	T. Nguyen
Sheet	1	of	1	Attorney Docket Number	M4065.0248/P248-C

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number Number-Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
	A	3,755,089*	8/28/1973	Rapids	
	B	4,341,846*	7/27/1982	Hough, et al.	
	C	4,910,169*	3/20/1990	Hoshino	
	D	4,987,750*	1/29/1991	Meckler	
	E	4,995,552*	2/26/1991	Choi, et al.	
	F	5,021,296*	6/4/1991	Suzuki, et al.	
	G	5,231,306*	7/27/1993	Meikle, et al.	
	H	5,472,563*	12/5/1995	Kogawa, et al.	
	I	5,518,760*	5/21/1996	Ferrier, et al.	
	J	5,703,408*	12/30/1997	Ming-Tsung, et al.	
	K	5,776,617*	7/7/1998	Brady, et al.	
	L	5,804,908*	9/8/1998	Yano	
	M	5,939,788*	8/17/1999	McTeer	
	N	6,165,885*	12/26/2000	Gaynes, et al.	
	O	6,218,302*	4/17/2001	Brawckelmann, et al.	
	P	6,268,291*	7/31/2001	Andricacos, et al.	
	Q	6,218,732*	4/17/2001	Russell, et al.	

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶

¹ Applicant's unique citation designation number (optional). ² See attached Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the application number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		P.J. Ding, et al. "Investigation of the Mechanism Responsible for the Corrosion Resistance of B implanted Copper" Nuclear Instruments and Methods in Physics Research B 1994, pgs. 260-263.*	
		W.A. Lanford, et al. "Low-temperature Passivation of Copper by Doping with Al or Mg" Thin Solid Films 262 (1995), pgs. 234-241.*	

Examiner Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² Applicant is to place a check mark here if English language Translation is attached.